



P.C.B LAYOUT
TOP VIEW ±0.05

PART NUMBER:
3MJFM - 8 8 * - 1 2 2

- SERIES
- 8 POSITION & 8 CONTACT
- CONTACT PLATED OPTION
- 1: GOLD FLASH
- 3: 3u" GOLD
- 5: 5u" GOLD
- 7: 15u" GOLD
- 9: 30u" GOLD
- 11: 6u" GOLD
- TAPE REEL PACKAGE

MATERIALS

HOUSING: HI-TEMP. PLASTIC (UL 94V-0)
SOLDER PAD: COPPER ALLOY, TIN PLATING
TERMINAL: COPPER ALLOY, GOLD PLATED

SPECIFICATION

CURRENT RATING: 1.5 AMP MAX
DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
CONTACT RESISTANCE: 30m OHMS MAX
INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
OPERATION TEMPERATURE: -40°C~+85°C

A	RELEASE	2012.2.27
REV.	DESCRIPTION	DATE

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TOLERANCES	TITLE	MODULAR JACK SERIES				
X.X ±0.3 X.XX ±0.2 X.XXX ±0.1 Angle ±5°		RJ45, PCB MOUNT, TOP ENTRY, SMT TYPE ALL PLASTIC				
	DRAWN BY	CHECKED BY	APPROVED BY			
	Janice	Lion	Benson			
10058	UNIT	SCALE	SIZE	DRAW NO.	REV.	Sheet
	MM	NONE	A4	3MJFM-003	A	1/1